

# INTERNATIONAL STANDARD

# IEC 61810-7

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## Electromechanical elementary relays – Part 7: Test and measurement procedures

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## INTERNATIONAL ELECTROTECHNICAL COMMISSION

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### ELECTROMECHANICAL ELEMENTARY RELAYS –

#### Part 7: Test and measurement procedures

#### FOREWORD

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International Standard IEC 61810-7 has been prepared by IEC technical committee 94: All-or-nothing electrical relays.

This second edition cancels and replaces the first edition published in 1997. This second edition constitutes a technical revision.

This new edition has been revised in order to

- update all normative references,
- adapt its contents to the newest issues of the other parts of this series of basic relay standards (IEC 61810-1 and IEC 61810-2),
- establish coherence with other IEC standards (for example of the IEC 60068-2 series),
- improve test and measurement procedures where appropriate,
- delete those tests no longer used in case of elementary relays for industrial application.

The text of this standard is based on the following documents:

FDIS	Report on voting
94/226/FDIS	94/231/RVD

Full information on the voting for the approval of this standard can be found in the report on voting indicated in the above table.

This publication has been drafted in accordance with the ISO/IEC Directives, Part 2.

IEC 61810 consists of the following parts, under the general title *Electromechanical elementary relays*:

Part 1: General and safety requirements

Part 2: Reliability

Part 7: Test and measurement procedures

The committee has decided that the contents of this publication will remain unchanged until the maintenance result date indicated on the IEC web site under "<http://webstore.iec.ch>" in the data related to the specific publication. At this date, the publication will be

- reconfirmed;
- withdrawn;
- replaced by a revised edition, or
- amended.

A bilingual version of this publication may be issued at a later date.

## ELECTROMECHANICAL ELEMENTARY RELAYS –

### Part 7: Test and measurement procedures

#### 1 Scope

This part of IEC 61810 states the test and measurement procedures for electromechanical elementary relays. It covers basic considerations which are, in general, common to all types of electromechanical elementary relays. Supplementary requirements may be necessitated by specific designs or application.

The test and measurement procedures of this standard are described as individual provisions covering a specific requirement. When combining them in a test programme, care must be taken (for example by suitable grouping of tested relays) to ensure that preceding tests do not devalue subsequent ones.

Where in this standard the term “specified” is used, this means a prescription in the appropriate documentation for the relay, for example manufacturer’s data sheet, test specification, customer detail specification. For application within the IECQ system such prescriptions are contained in the detail specification as defined in Clause A.7 of QC 001001.

NOTE 1 To improve the readability of this standard, the term “relay” is generally used in place of “electromechanical elementary relay”.

NOTE 2 Requirements and tests related to the type testing of electromechanical elementary relays are contained in IEC 61810-1. For that purpose, the generally described test and measurement procedures of this standard have been prescribed in a more restricted and stringent form in IEC 61810-1.

NOTE 3 Standards covering relays subjected to quality assessment in accordance with IECQ are compiled in the IEC 61811 series of publications.

#### 2 Normative references

The following referenced documents are indispensable for the application of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 60068-2-1:1990, *Environmental testing – Part 2: Tests – Tests A: Cold*  
Amendment 1 (1993)  
Amendment 2 (1994)

IEC 60068-2-2:1974, *Environmental testing – Part 2: Tests – Tests B: Dry heat*  
Amendment 1 (1993)  
Amendment 2 (1994)

IEC 60068-2-6:1995, *Environmental testing – Part 2: Tests – Test Fc: Vibration (sinusoidal)*

IEC 60068-2-7:1983, *Environmental testing – Part 2: Tests – Test Ga: Acceleration, steady state*  
Amendment 1 (1986)

IEC 60068-2-10:2005, *Environmental testing – Part 2: Tests – Test J and guidance: Mould growth*

IEC 60068-2-11:1981, *Environmental testing – Part 2: Tests – Test Ka: Salt mist*

IEC 60068-2-13:1983, *Environmental testing – Part 2: Tests – Test M: Low air pressure*

IEC 60068-2-14:1984, *Environmental testing – Part 2: Tests – Test N: Change of temperature*  
Amendment 1 (1986)

IEC 60068-2-17:1994, *Environmental testing – Part 2: Tests – Test Q: Sealing*

IEC 60068-2-20:1979, *Environmental testing – Part 2: Tests – Test T: Soldering*  
Amendment 2 (1987)

IEC 60068-2-21:1999, *Environmental testing – Part 2-21: Tests – Test U: Robustness of terminations and integral mounting devices*

IEC 60068-2-27:1987, *Environmental testing – Part 2: Tests – Test Ea and guidance: Shock*

IEC 60068-2-29:1987, *Environmental testing – Part 2: Tests – Test Eb and guidance: Bump*

IEC 60068-2-30:2005, *Environmental testing – Part 2: Tests – Test Db: Damp heat, cyclic (12 + 12-hour cycle)*

IEC 60068-2-42:2003, *Environmental testing – Part 2-42: Tests – Test Kc: Sulphur dioxide test for contacts and connections*

IEC 60068-2-43:2003, *Environmental testing – Part 2-43: Tests – Test Kd: Hydrogen sulphide test for contacts and connections*

IEC 60068-2-45:1980, *Environmental testing – Part 2: Tests – Test XA and guidance: Immersion in cleaning solvents*  
Amendment 1 (1993)

IEC 60068-2-58:2004, *Environmental testing – Part 2-58: Tests – Test Td – Test methods for solderability, resistance to dissolution of metallization and to soldering heat of surface mounting devices (SMD)*

IEC 60068-2-64:1993, *Environmental testing – Part 2: Test methods – Test Fh: Vibration, broad-band random (digital control) and guidance*

IEC 60068-2-68:1994, *Environmental testing – Part 2: Tests – Test L: Dust and sand*

IEC 60068-2-78:2001, *Environmental testing – Part 2-78: Tests – Test Cab: Damp heat, steady state*

IEC 60512-7: 1993, *Electromechanical components for electronic equipment; basic testing procedures and measuring methods – Part 7: Mechanical operating tests and sealing tests*

IEC 60695-2 (all parts), *Fire hazard testing – Part 2: Test methods*

IEC 60695-2-10:2000, *Fire hazard testing – Part 2-10: Glowing/hot wire based test methods – Glow-wire apparatus and common test procedure*

IEC 60695-2-11:2000, *Fire hazard testing – Part 2-11: Glowing/hot wire based test methods – Glow-wire flammability test method for end-products*

IEC 60695-2-12:2000, *Fire hazard testing – Part 2-12: Glowing/hot wire based test methods – Glow-wire flammability test method for materials*

IEC 60695-2-13:2000, *Fire hazard testing – Part 2-13: Glowing/hot wire based test methods – Glow-wire ignitability test method for materials*

IEC 60695-11-5:2004, *Fire hazard testing – Part 11-5: Test flames – Needle-flame test method – Apparatus, confirmatory test arrangement and guidance*

IEC 60999-1:1999, *Connecting devices – Electrical copper conductors – Safety requirements for screw-type and screwless-type clamping units – Part 1: General requirements and particular requirements for clamping units for conductors from 0,2 mm<sup>2</sup> up to 35 mm<sup>2</sup> (included)*

IEC 61210:1993, *Connecting devices – Flat quick-connect terminations for electric copper conductors – Safety requirements*

IEC 61180-1:1992, *High-voltage test techniques for low-voltage equipment – Part 1: Definitions, test and procedure requirements*

IEC 61180-2:1994, *High-voltage test techniques for low-voltage equipment – Part 2: Test equipment*

IEC 61672-1:2002, *Electroacoustics – Sound level meters – Part 1: Specifications*

IEC 61810-1:2004, *Electromechanical elementary relays – Part 1: General and safety requirements*

IECQ QC 001001:2000, *IEC Quality Assessment System for Electronic Components (IECQ) – Basic Rules*